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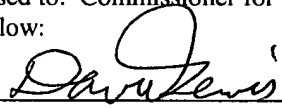
IN THE  
UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANTS: Steven F. Reiber et al.  
SERIAL NO.: 09/514,454  
FILING DATE: February 25, 2000  
TITLE: Dissipative Ceramic Bonding Tip  
GROUP ART UNIT: 1725  
ATTY.DKT.NO.: PA1118US

**CERTIFICATE OF MAILING**

I hereby certify that this paper is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on the date printed below:

Date: May 24, 2001

  
David Lewis

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WASHINGTON, D.C. 20231

**AMENDMENT/RESPONSE**

Sir,

In response to the Official Action mailed February 28, 2001, (paper #11) kindly  
enter the following amendment in the above-identified patent application:

05/31/2001 RHARIS1 00000120 09514454

01 FC:202 120.00 OP  
02 FC:203 54.00 OP

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